

## 1 Mbit/s High Speed Transistor Coupler

#### **Features**

- High speed 1Mbit/s
- High isolation voltage between input and output (Viso=3750 Vrms)
- Guaranteed CTR performance from 0°C to 70°C
- Wide operating temperature range of -55°C to 100°C
- Green Package
- Regulatory Approvals
  - UL UL1577 (E364000)
  - VDE EN60747-5-5(VDE0884-5)
  - CQC GB4943.1, GB8898
  - IEC60065, IEC60950

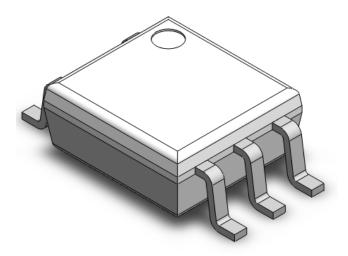
#### **Description**

The CTM452 and CTM453 devices each consist of an infrared emitting diode, optically coupled to a high speed photo detector transistor. A separate the connection for photodiode bias output-transistor collector increase the speed by several orders of magnitude over conventional couplers phototransistor by reducing the base-collector capacitance of the input transistor. The devices are packaged in a Mini-Flat package.

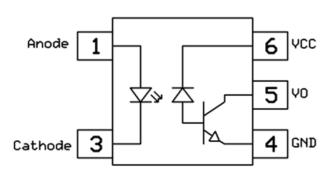
#### **Applications**

- Line receivers
- Telecommunication equipment
- Feedback loop in switch-mode power supplies
- Home appliances
- High speed logic ground isolation

### **Package Outline**



### **Schematic**





## 1 Mbit/s High Speed Transistor Coupler

## Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
Viso	Isolation voltage *1	3750	V <sub>RMS</sub>	
Topr	Operating temperature	-55 ~ +100	°C	
Тѕтс	Storage temperature	-55 ~ +125	°C	
TsoL	Soldering temperature *2	260	°C	
Emitter		•	•	•
l <sub>F</sub>	Forward current	25	mA	
<b>I</b> FP	Peak forward current (50% duty, 1ms P.W)	50	mA	
I <sub>F(TRANS)</sub>	Peak transient current (≤1µs P.W,300pps)	1	А	
V <sub>R</sub>	Reverse voltage	5	V	
P <sub>D</sub>	Power dissipation	45	mW	
Detector		•	•	•
P <sub>D</sub>	Power dissipation	100	mW	
I <sub>O(AVG)</sub>	Average Output current	8	mA	
I <sub>O (Peak)</sub>	Peak Output current	16	mA	
Vo	Output voltage	-0.5 to 20	V	
Vcc	Supply voltage	-0.5 to 30		



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#### **Electrical Characteristics**

 $T_A = 0$  - 70°C (unless otherwise specified). Typical values are measured at  $T_A = 25^{\circ}$ C and  $V_{CC} = 5V$ 

#### **Emitter Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	IF = 16mA	-	1.45	1.6	V	
VR	Reverse Voltage	IR = 10μA	5.0	-	-	V	
ΔV <sub>F</sub> /ΔT <sub>A</sub>	Temperature coefficient of forward voltage	IF =16mA	-	-1.6	-	mV/°C	

#### **Detector Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Мах	Units	Notes
	Logic High Output Current	I <sub>F</sub> =0mA, V <sub>O</sub> =V <sub>CC</sub> =5.5V,		0.001	0.5	μА	
		T <sub>A</sub> =25°C	-				
Іон		I <sub>F</sub> =0mA, V <sub>O</sub> =V <sub>CC</sub> =15V,		0.01	1		
		T <sub>A</sub> =25°C	-				
		I <sub>F</sub> =0mA, V <sub>O</sub> =V <sub>CC</sub> =15V	-	-	50		
loo		I <sub>F</sub> =16mA, V <sub>O</sub> =Open,	-	120	200	μA	
ICCL	Logic Low Supply Current	Vcc=15V					
	Logic High Supply Current	I <sub>F</sub> =0mA, V <sub>O</sub> =Open, V <sub>CC</sub> =15V,	-	0.01	1		
I a a		T <sub>A</sub> =25°C				۸	
Іссн		IF=0mA, VO=Open,		-	2	- μΑ	
		VCC=15V	-				



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#### **Transfer Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
	Current Transfer Ratio	I <sub>F</sub> =16mA, V <sub>O</sub> =0.4V,	20	-	50		
CTD		V <sub>CC</sub> =4.5V, T <sub>A</sub> =25°C	20			%	
CTR		I <sub>F</sub> =16mA, V <sub>O</sub> =0.5V,	15	-	-	70	
		V <sub>CC</sub> =4.5V	15				
	Logic Low Output Voltage	I <sub>F</sub> =16mA, I <sub>O</sub> =3mA, V <sub>CC</sub> =4.5V,	-	-	0.4		
		T <sub>A</sub> =25°C				V	
Vol		I <sub>F</sub> =16mA, I <sub>O</sub> =2.4mA,	-	-	0.5	V	
		V <sub>CC</sub> =4.5V					

#### **Electrical Characteristics**

 $T_A = 0$  - 70°C (unless otherwise specified). Typical values are measured at  $T_A = 25^{\circ}$ C and  $V_{CC} = 5V$ 

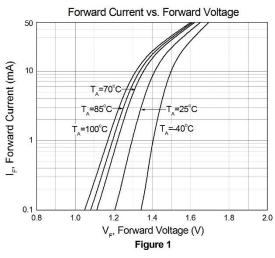
#### **Switching Characteristics**

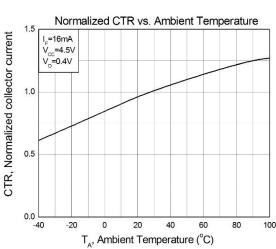
Symbol	Parameters		Test Conditions	Min	Тур	Max	Units	Notes
$T_{PHL}$	Propagation Delay Time Logic High to Logic Low		$I_F=16mA,\ R_L=1.9K\Omega,$ $T_A=25^{\circ}C$	-	0.35	0.8	μs	
			$I_F$ =16mA, $R_L$ =1.9K $\Omega$	-	1	1.0		
T <sub>PLH</sub>	Propagation Delay Time Logic Low		$I_F=16mA, R_L=1.9K\Omega,$ $T_A=25^{\circ}C$	-	0.3	0.8	μs	
	to Logic High I <sub>F</sub> =16mA, R <sub>L</sub> =	$I_F$ =16mA, $R_L$ =1.9K $\Omega$	-	1	1.0			
CM	Common Mode Transient Immunity at Logic High	CTM452	$I_F = 0 mA$ , $V_{CM}=10 Vp-p$ , $R_L=1.9 K\Omega$ , $T_A=25 ^{\circ} C$	5,000	-	-	V/	
СМн		CTM453	$I_F = 0 mA \ , \ V_{CM} = 1500 Vp - p,$ $R_L = 1.9 K\Omega, \ T_A = 25 ^{\circ} C$	15,000	1		V/µs	
CML	Transient Immunity at	CTM452	$I_F = 16 mA , V_{CM} = 10 Vp-p,$ $R_L = 1.9 K\Omega, T_A = 25 ^{\circ} C$	5,000	ı	ı	V/µs	
OIVIL		CTM453	$I_F = 16 mA , V_{CM} = 1500 Vp-p,$ $R_L = 1.9 K\Omega, T_A = 25 ^{\circ}C$	15,000	-		ν/μ5	

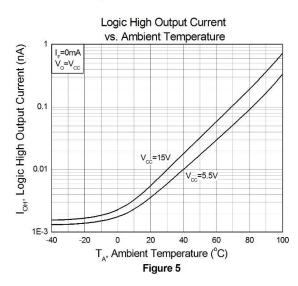


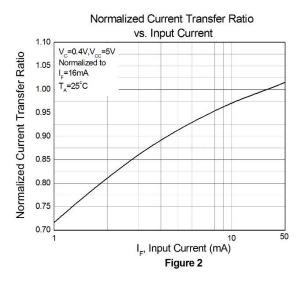
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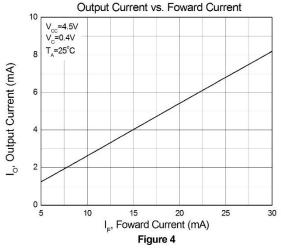
#### **Typical Characteristic Curves**

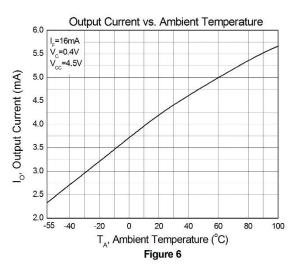








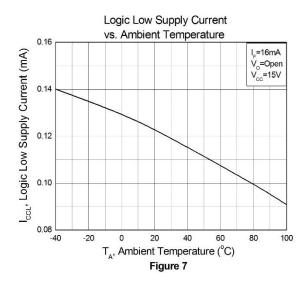


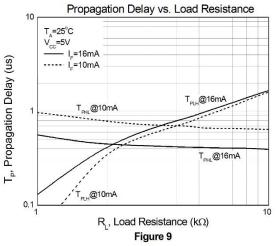


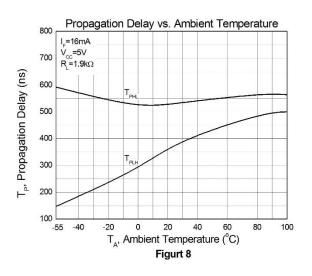


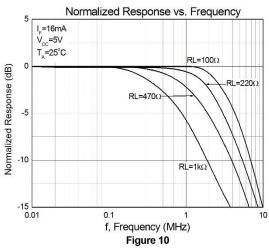
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## **Typical Characteristic Curves**





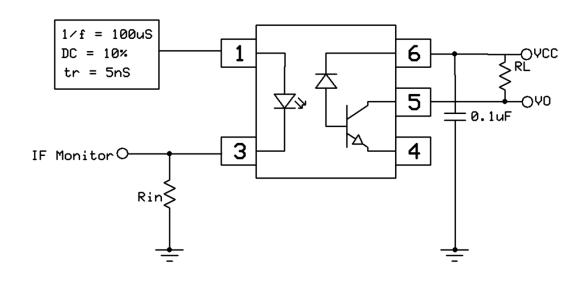


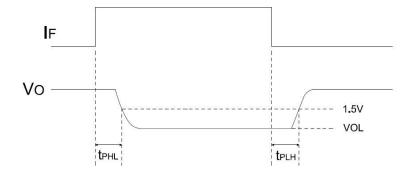




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#### **Test Circuits**



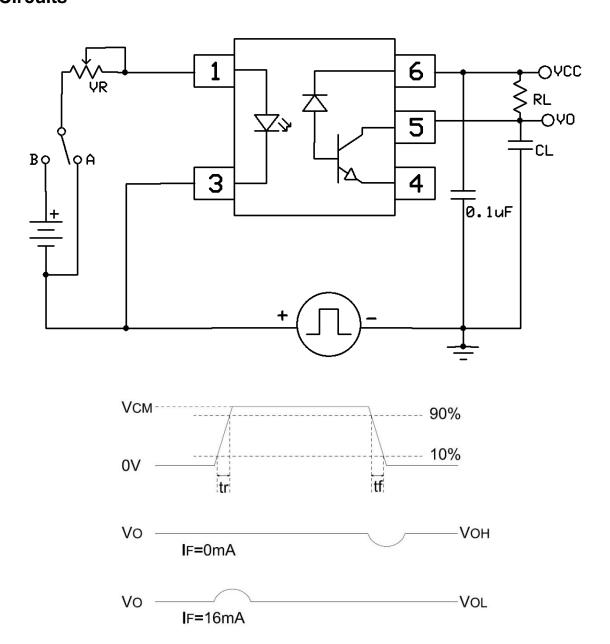


Switching Time Test Circuit



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#### **Test Circuits**

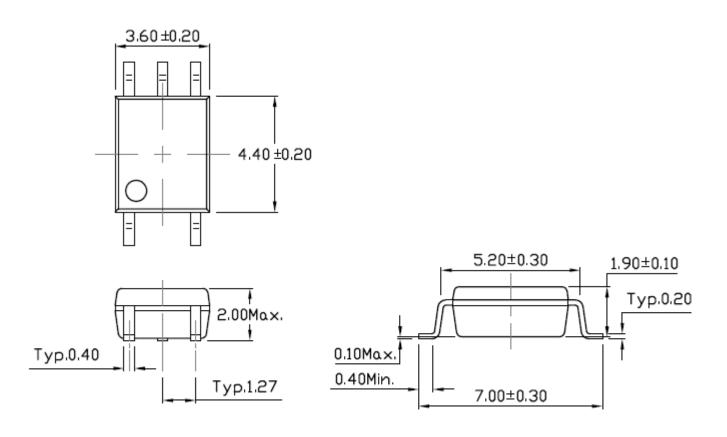


CMR Test Circuit

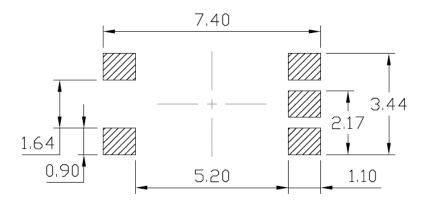


## 1 Mbit/s High Speed Transistor Coupler

## Package Dimension Dimensions in mm unless otherwise stated



#### Recommended Solder Mask Dimensions in mm unless otherwise stated





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## **Marking Information**



Note:

CT : Denotes "CT Micro"

M453 : Product Number

V : VDE Option
Y : Fiscal Year
WW : Work Week

K : Production Code

## **Ordering Information**

## CTM45X(V)(Z)

X = Part No. (X=2 or 3)

V = VDE Option (V or none)

Z = Tape and reel option (T1, T2, T3 or T4)

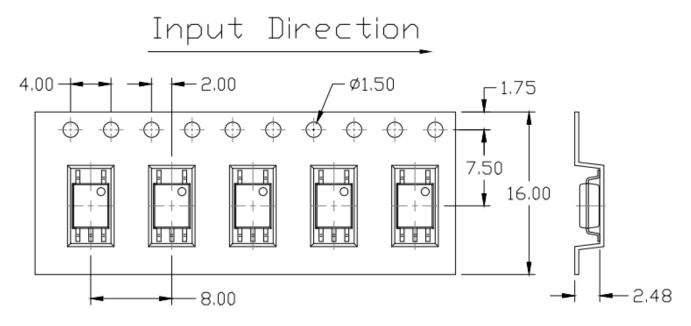
Option	Description	Quantity
T1	Surface Mount Lead Forming – With Option 1 Tapping	3000 Units/Reel
T2	Surface Mount Lead Forming – With Option 2 Tapping	3000 Units/Reel
Т3	Surface Mount Lead Forming – With Option 3 Tapping	3000 Units/Reel
T4	Surface Mount Lead Forming – With Option 4 Tapping	3000 Units/Reel



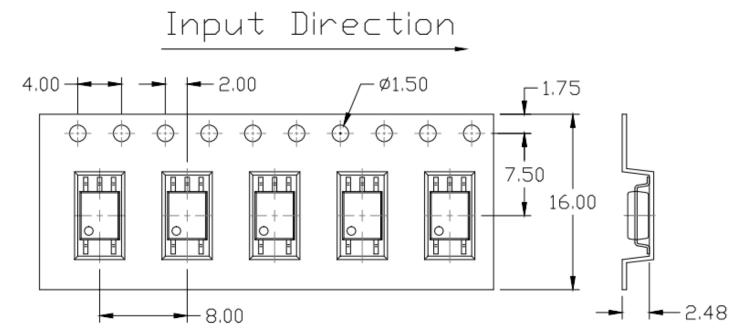
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#### Carrier Tape Specifications Dimensions in mm unless otherwise stated

## **Option T1**



#### **Option T2**



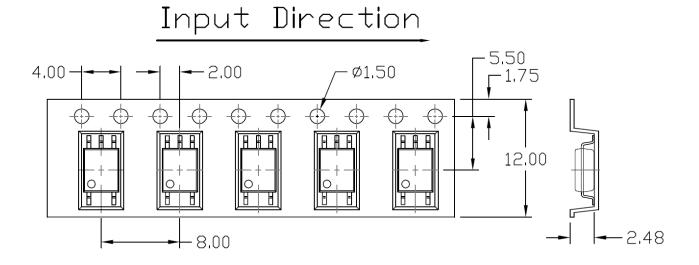


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#### **Option T3**

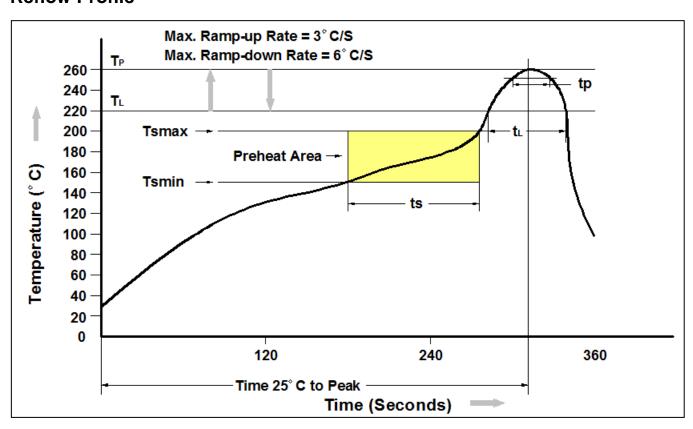
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## **Option T4**





#### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T∟)	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



# 5 Pin Mini-Flat

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